## swissbit®

**Product Fact Sheet** 

**Industrial** M.2 PCle SSD

N-30m2 Series PCle 3.1, 3D TLC

Industrial Temperature Grade

February 23, 2023 1.01 Date:

Revision:





## **Product Summary**

- Capacities: 240 GBytes, 480 GBytes, 960 GBytes, 1920 GBytes, 3840 GBytes
- Form Factor: PCI Express M.2 2242/2280 (42/80 mm x 22 mm x 3.8 mm)
- Compliance<sup>1</sup>: PCI Express (PCIe) Base Specification Revision 3.1
- Interface: Gen3 x 4 Lanes
  - Drive operates in x1 mode in x1 M.2 PCle slots
  - o Drive operates in x2 mode in x2 M.2 PCle slots
  - o Drive operates in x4 mode in x4 M.2 PCle slots
- Command Sets: Supports NVMe 1.4
- Target Performance:
  - Read Performance: Sequential Read up to 3,510 MBytes/s, Random Read 4K up to 475,900 IOPS
  - Write Performance: Sequential Write up to 3,110 MBytes/s, Random Write 4K up to 520,000 IOPS
- Operating Temperature Range<sup>2</sup>:
  - o Industrial: -40 °C to 85 °C
- Storage Temperature Range: -40 °C to 85 °C
- Power:
  - Power States PSo, PS1, PS2, PS3 and PS4
  - Thermal Throttling supported
- Data Retention<sup>3</sup>: 10 Years @ Life Begin; 1 Year @ Life End, @40°C
- Shock/Vibration: 1,500 g l 50 g
- High-Performance Processor with Integrated, Parallel Flash Interface Engines:
  - Triple-Level Cell (TLC) 3D NAND Flash
  - DDR4 DRAM based Controller architecture
  - o 240 bit LDPC correction per 2 kByte
- · High Reliability:
  - Mean Time Between Failure (MTBF): > 3,000,000 hours
  - o Data Reliability: < 1 non-recoverable error per 10<sup>16</sup> bits read

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<sup>&</sup>lt;sup>1</sup> To check the compatibility of the customer system and the storage device is part of the customer's responsibility. Swissbit can provide guidance and support on request.

<sup>&</sup>lt;sup>2</sup> Adequate airflow is required to ensure the temperature, as reported in the S.M.A.R.T. data, does not exceed 125°C (industrial temperature drive).

<sup>3</sup> NAND Flash suppliers refer to JEDEC JESD47 and JESD22 for Data Retention testing. Based on the information provided by the NAND Flash suppliers, Data Retention is targeted as shown



## **Product Features**

- Dynamic and Static Wear Leveling
- Subpage Mode Flash Translation Layer (FTL)
- Data Care Management
  - Active: Adaptive Read Refresh
  - Passive: Background Media Scan
- Lifetime Enhancements
  - Dynamic Bad Block Remapping
  - Write Amplification Reduction
- Data set management support (TRIM)
- Active State Power Management (ASPM) Support
- In-Field Firmware Update<sup>4</sup>
- Enterprise-Grade Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T., Telemetry)
- 30 µinch (0.8 µm) Gold-Plated Connector (IPC-6012C Class 2 Compliant)
- End-to-End (E2E) Data Protection
- On-Board Power Fail Protection
- AES256 Encryption
- TCG Opal (on request)
- Crypto erase
- Life Cycle Management
- Controlled "Locked" BOM
- RoHS / REACH Compliant
- Swissbit Life Time Monitoring (SBLTM) Tool and SDK for SBLTM (on request)





























## Why Swissbit?

Swissbit is focused on the design, development, manufacture, and support of leading edge memory and storage solutions for the worldwide OEM/ODM marketplace. As a global supplier, Swissbit recognizes and addressees the higher level of application requirements of today's industrial, Netcom, and automotive customers by providing best-in-class products and services, with uncompromised attention to driving overall value and quality.

<sup>4</sup> The support of In-Field FW update capabilities on host systems is recommended.



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